

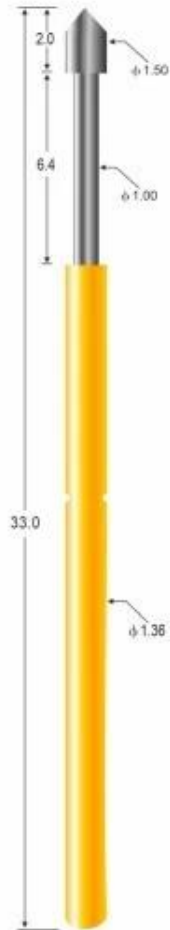


SFENG 1984 PCB 1.90mm (0.0748") thickness. (PCB 1.35mm (0.0532") thickness, 1.40mm (0.0551") thickness).  
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Model	SF-P100
Thickness	1.90mm(.0748")
Material	FR-4: 1.35mm(.0532") FR-4: 1.40mm(.0551")
Length	6.3(.2481")
Weight	120g
Plating	Plating: Be Cu, Rh Plating: 1.0um, 1.0um Plating: 1.0um, 1.0um
Current	3A
Resistance	50mΩ
MOQ	100
Lead time	Standard lead time 7 days



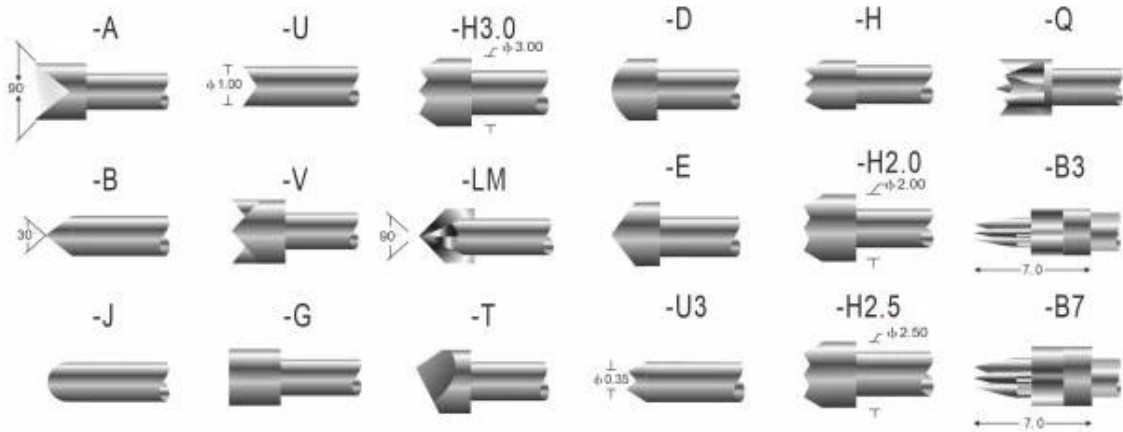


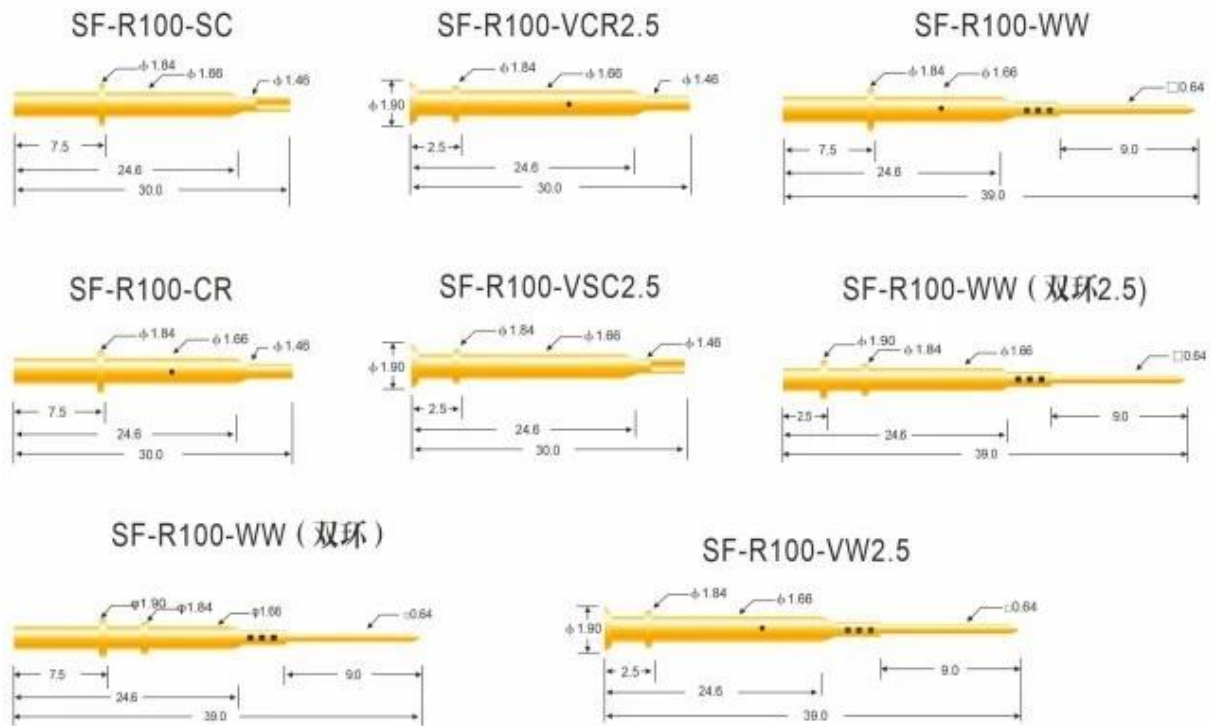
SF-P100-E

## 技术规格 PROBE SPECIFICATIONS

Recommended minimum center 最小间距	1.90mm(.0748 ")
Mounting hole size 钻孔尺寸	压克力: 1.35mm(.0532 ") 电木板、玻璃纤维板: 1.40mm(.0551 ")
Full travel 行程	6.3(.2481 ")
Spring force 弹簧压力	120g(克)
Materials and finishes 材料及涂饰	Plunger:SK4, Ni or Au plated BeCu, Ni or Au plated Phosphor bronze, Ni or Au plated Barrel:Phosphor bronze, Au plated Spring:Stainless steel
Current ration 额定电流	3A(安培)
Contact resistance 接触电阻	50mΩ(毫欧姆)

Receptacle specifications  
Materials and finishes: Phosphor bronze,Gold plated





## 技术规格 PROBE SPECIFICATIONS

Recommended minimum center 最小间距	2.54mm(.1000 ")
Mounting hole size 钻孔尺寸	压克力: 1.70mm(.0670 ") 电木板、玻璃纤维板: 1.75mm(.0689 ")
Materials and finishes 材料及涂饰	Barrel: Brass, Gold plated
Connections 接线形式	Crimp: R100-VCR2.5, R100-CR Solder cup: R100-VSC2.5, R100-SC Wire wrap: R100-VW2.5, R100-WW, R100-WW(双环2.5), R100-WW(双环)

Receptacle specifications  
Materials and finishes: Phosphor bronze, Gold plated



1. 间距 24 的 24 针 探针 阵列 探针 阵列 探针 阵列 探针 阵列.
2. 探针 阵列 阵列 OEM 定制 阵列.
3. 探针 阵列 阵列 阵列 阵列 阵列 阵列 阵列 阵列 阵列 阵列.
4. 探针 阵列 阵列 阵列 阵列 阵列 阵列 阵列 阵列 阵列 阵列.



1. PCB, ICT, FCT 測試 設備 測試 設備 設備 (設備);
2. 設備, 設備 設備, 設備, 設備 設備 設備 設備 設備 設備 設備 設備 設備 設備 (設備)
3. BGA 設備 設備 設備 設備 設備 設備;
4. 設備 設備 設備 設備, 設備 設備, QZ 設備 VZ 設備 LM 設備;
5. 設備 設備, 設備 設備, 設備 設備 設備;
6. 設備 設備 / 設備;
7. 設備 設備 設備 設備, 30# OK 設備, 設備 設備 設備, POM, 設備 設備

設備 設備 設備 設備 設備 設備 設備 設備 設備 設備 設備!



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



5. Finished products

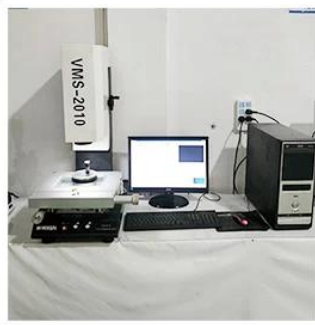


6. Packing





1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope



2023 ISO Certificate



Patent for Coaxial Structure



Patent for Honeycomb current probe



DHL, UPS, FedEx, TNT, EMS 〇〇〇 〇〇 〇〇 〇〇

〇〇 〇〇 〇〇〇 〇〇 〇〇〇〇 〇〇〇〇〇 〇〇 〇〇〇 〇〇〇〇〇〇 〇〇 〇〇 〇〇〇〇 Exwork, FOB, CNF, CIF 〇〇〇 〇〇〇 〇 〇〇〇〇.



**Q1.** ၀၀၀ ၀၀၀၀၀၀၀?

A1: ၀၀၀၀, ၀၀၀ ၀၀၀ ၀၀၀ ၀ ၀ ၀၀ ၀၀၀ ၀၀ ၀၀၀၀ ၀၀၀၀၀၀.

**Q2.**၀၀၀ ၀၀၀ ၀၀၀၀၀?

A2: ၀၀၀ ၀၀၀၀ QC ၀၀ ၀၀ ၀၀၀ ၀၀၀ ၀၀၀၀ ၀၀ ၀၀၀ ၀၀, ၀၀ ၀၀ ၀ ၀၀၀ ၀၀၀၀ ၀၀၀ ၀၀၀ ၀၀၀၀၀.

**Q3.**၀၀၀ ၀၀၀၀?

A3: ၀၀၀ ၀၀၀၀၀၀ ၀၀ ၀၀၀၀ ၀၀ ၀၀၀ ၀၀ ၀၀၀ ၀၀၀၀.

**Q4.**၀၀၀၀ ၀၀၀ ၀၀၀၀၀?

A4: ၀၀၀ ၀၀၀၀ ၀၀၀၀၀ ၀၀၀၀ ၀၀ ၀၀၀၀၀ ၀၀ ၀၀, ၀၀, ၀၀ ၀၀ ၀၀ ၀ ၀၀၀ ၀၀၀၀၀၀. ၀၀၀၀.

**Q5.**၀၀၀ ၀၀၀၀ ၀၀?

A5: ㄛ! ㄛㄛㄛ ㄛㄛㄛ ㄛㄛㄛ ㄛㄛㄛㄛ ㄛㄛㄛㄛㄛ ㄛㄛ ㄛㄛ ㄛㄛㄛ ㄛㄛㄛㄛ ㄛㄛ ㄛㄛㄛ ㄛㄛㄛㄛ.

**Q6.**ㄛㄛㄛ ㄛㄛㄛ ㄛ ㄛㄛㄛ?

A6: ㄛ, ㄛㄛㄛ ㄛㄛㄛ ㄛㄛ ㄛㄛㄛ ㄛㄛㄛ ㄛㄛㄛ ㄛㄛㄛㄛ.

**Q7.OEM**ㄛㄛ **ODM** ㄛㄛㄛ ㄛㄛㄛ ㄛ ㄛ ㄛㄛㄛ?

A7: ㄛㄛㄛ OEM/ODM ㄛㄛㄛ ㄛㄛ ㄛㄛ ㄛㄛㄛ ㄛㄛㄛㄛ. ㄛㄛㄛ ㄛㄛㄛㄛ ㄛㄛㄛㄛㄛㄛ ㄛㄛㄛㄛ ㄛㄛ ㄛㄛㄛㄛ.

**Q8.** ㄛㄛ ㄛㄛㄛ ㄛㄛㄛ ㄛㄛㄛㄛ ㄛㄛㄛ?

A8: T/T ㄛㄛㄛ ㄛ ㄛㄛㄛ, L/C ㄛㄛ ㄛㄛㄛㄛ ㄛㄛㄛ ㄛ ㄛㄛㄛ ㄛ ㄛㄛㄛ ㄛㄛㄛ MOQ ㄛㄛㄛㄛ.